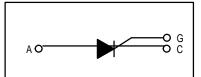
# **Silicon Controlled Rectifiers** Reverse Blocking Triode Thyristors

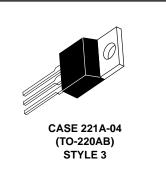
... designed for industrial and consumer applications such as temperature, light and speed control; process and remote controls; warning systems; capacitive discharge circuits and MPU interface.

- Center Gate Geometry for Uniform Current Density
- All Diffused and Glass-Passivated Junctions for Parameter Uniformity and Stability
- Small, Rugged Thermowatt Construction for Low Thermal Resistance, High Heat
  Dissipation and Durability
- Low Trigger Currents, 200 μA Maximum for Direct Driving from Integrated Circuits

# MCR72 Series







#### **MAXIMUM RATINGS** ( $T_J = 25^{\circ}C$ unless otherwise noted.)

Rating		Symbol	Value	Unit	
Peak Repetitive Forward and Reverse Blocking Voltage <sup>(1)</sup> (T <sub>J</sub> = $-40$ to $110^{\circ}$ C, 1/2 Sine Wave, R <sub>GK</sub> = 1k $\Omega$ )	MCR72-2 MCR72-3 MCR72-4 MCR72-6 MCR72-8 MCR72-10	VDRM or VRRM	50 100 200 400 600 800	Volts	
On-State RMS Current (T <sub>C</sub> = 83°C)		IT(RMS)	8	Amps	
Peak Non-repetitive Surge Current (1/2 Cycle, 60 Hz, T <sub>J</sub> = -40 to 110°C)		ITSM	100	Amps	
Circuit Fusing (t = 8.3 ms)		l <sup>2</sup> t	40	A <sup>2</sup> s	
Peak Gate Voltage (t ≤ 10 μs)		V <sub>GM</sub>	±5	Volts	
Peak Gate Current (t ≤ 10 μs)		I <sub>GM</sub>	1	Amp	
Peak Gate Power (t ≤ 10 μs)		PGM	5	Watts	
Average Gate Power		PG(AV)	0.75	Watts	
Operating Junction Temperature Range		Tj	-40 to +110	°C	

1. V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



(cont.)

### **MCR72 Series**

#### MAXIMUM RATINGS — continued

Rating	Symbol	Value	Unit	
Storage Temperature Range	T <sub>stg</sub>	-40 to + 150	°C	
Mounting Torque	_	8	in. lb.	

#### THERMAL CHARACTERISTICS

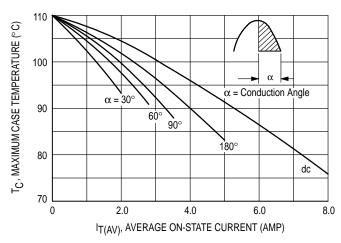
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	2.2	°C/W
Thermal Resistance, Junction to Ambient	R <sub>θJA</sub>	60	°C/W

**ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C, R<sub>GK</sub> = 1 k $\Omega$  unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
Peak Forward or Reverse Blocking Current <sup>(1)</sup> (V <sub>AK</sub> = Rated V <sub>DRM</sub> or V <sub>RRM</sub> ) $T_J = 25^{\circ}C$ $T_J = 110^{\circ}C$	<sup>I</sup> DRM <sup>, I</sup> RRM			10 500	μΑ μΑ
On-State Voltage (I <sub>TM</sub> = 16 A Peak, Pulse Width ≤ 1 ms, Duty Cycle ≤ 2%)	VTM	—	1.7	2	Volts
Gate Trigger Current (Continuous dc) <sup>(2)</sup> ( $V_D = 12 V, R_L = 100 \Omega$ )	IGT	—	30	200	μΑ
Gate Trigger Voltage (Continuous dc) $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega)$ $(V_D = \text{Rated V}_{DRM}, \text{ R}_L = 10 \text{ k}\Omega, \text{ T}_J = 110^{\circ}\text{C})$	VGT	 0.1	0.5 —	1.5 —	Volts
Holding Current $(V_D = 12 \text{ V}, I_{TM} = 100 \text{ mA})$	Ч	—	—	6	mA
Critical Rate-of-Rise of Forward Blocking Voltage (V <sub>D</sub> = Rated V <sub>DRM</sub> , T <sub>J</sub> = 110°C, Exponential Waveform)	dv/dt	—	10	_	V/µs
Gate Controlled Turn-On Time ( $V_D$ = Rated $V_{DRM}$ , $I_{TM}$ = 16 A, $I_G$ = 2 mA)	tgt	_	1	_	μs

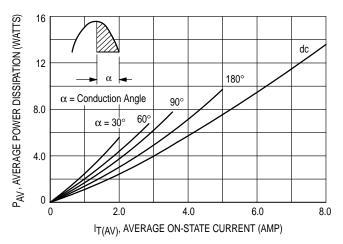
1. Ratings apply for negative gate voltage or R<sub>GK</sub> = 1 kΩ. Devices shall not have a positive gate voltage concurrently with a negative voltage on the anode. Devices should not be tested with a constant current source for forward and reverse blocking capability such that the voltage applied exceeds the rated blocking voltage.

2. Does not include RGK current.



### FIGURE 1 – AVERAGE CURRENT DERATING

#### FIGURE 2 - ON-STATE POWER DISSIPATION



## FIGURE 3 – NORMALIZED GATE CURRENT

60

TJ, JUNCTION TEMPERATURE (°C)

40

80

90

100

 $V_{D} = 12 \text{ Vdc}$ 

3.0

2.0

1.0

0.5

0.3

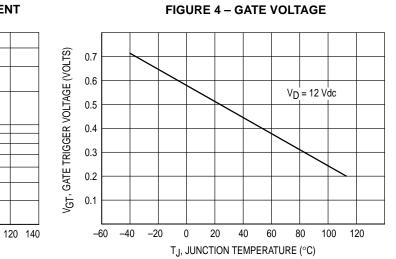
-40

-20

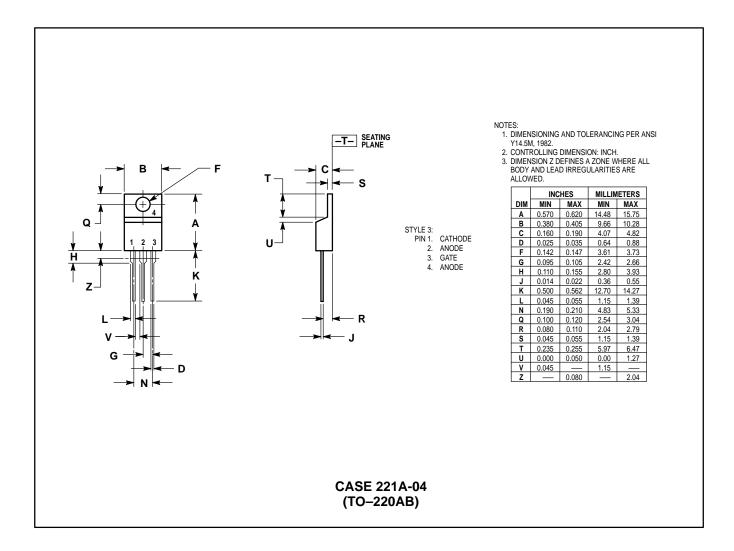
0

20

NORMALIZED GATE CURRENT



### PACKAGE DIMENSIONS



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